



RE1370-LF

- Epoxy fibre-glass FR4 0.80 mm
- Single-sided 35 µm Cu
- Without holes
- Hot air leveling (HAL-leadfree)
- 10 self-adhesive DIL8-Adapters
- Pre-scratched rated break point for the separation of individual modules from the board
- Size 22.00 x 117.35 mm